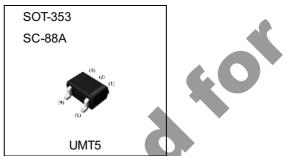


# NPN complex transistor with switching diode

Parameter	Value
V <sub>CEO</sub>	50V
IC	150mA

## Outline



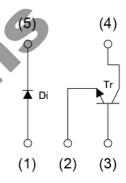
### Features

1)The 2SC4617 and a diode are housed independently in a SOT-353 package.

### •Inner circuit



(3) Tr Base



# Application

# Packaging specifications

<ul><li>Application</li><li>Low-frequency</li><li>Packaging spec</li></ul>	eifications			(4) Tr Collect (5) Di Catho		Di   (1) (2)	(3)
Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
UML2N	SOT-353 (UMT5)	2021	TR	180	8	3000	L2

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

## Pin No.1-5 Diode

Parameter	Symbol	Value	Unit
Reverse voltage	V <sub>R</sub>	80	V
Repetitive peak reverse voltage	V <sub>RM</sub>	80	V
Average rectified current	I <sub>F</sub>	100	mA
Peak forward current	I <sub>FM</sub>	300	mA
Surge current	I <sub>surge</sub>	4	Α
Rated in slash put frequency	f	100	MHz

### Pin No.2-3-4 Transistor

Parameter	Symbol	Value	Unit
Collector-base voltage	V <sub>CBO</sub>	60	V
Collector-emitter voltage	V <sub>CEO</sub>	50	V
Emitter-base voltage	V <sub>EBO</sub>	6	V
Collector current	Ic	150	mA

### **Each element**

Parameter	Symbol	Value	Unit
Power dissipation	P <sub>D</sub> *1,*2	150	mW/Total
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 <b>~</b> +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

### Pin No.1-5 Diode

Darameter	Cumah al	Canditions	Values			l leit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Forward voltage	$V_{F}$	I <sub>F</sub> = 100mA	-	-	1.2	V
Reverse current	$I_R$	V <sub>R</sub> = 70V	-		100	nA
Capacitance between terminals	$C_{T}$	V <sub>R</sub> = 6V , f = 1MHz	-	-	3.5	pF
Reverse recovery time	t <sub>rr</sub>	$V_R = 6V$ , $I_F = 5mA$ $R_L = 50Ω$ (Figure 1)		).	4	ns

### Pin No.2-3-4 Transistor

	r		i			
Parameter	Symbol	Conditions		Values		Unit
r arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 50μA	60	ı	ı	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 50μA	6	ı	ı	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 60V	-	1	100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 5V	-	1	100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C}$ = 50mA, $I_{\rm B}$ = 5mA	-	ı	400	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = 6V, I_C = 1mA$	120	ı	560	-
Transition frequency	f <sub>T</sub> *3	$V_{CE} = 12V, I_{E} = -2mA,$ f = 100MHz	-	180	-	MHz
Output capacitance	C <sub>ob</sub>	$V_{CB} = -12V, I_{E} = 0A,$ f = 1MHz	-	2.0	3.5	pF

<sup>\*1</sup> Each termunal mounted on a reference land.

<sup>\*2 120</sup>mW per element must not be exceeded.

<sup>\*3</sup> Characteristics of built-in transistor.

## ● Electrical characteristic curves(Ta=25°C) < For Diode>

Fig.1 Reverse Current vs.
Reverse Voltage

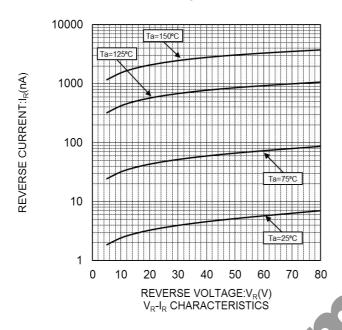


Fig.2 Forward Current vs. Forward Voltage

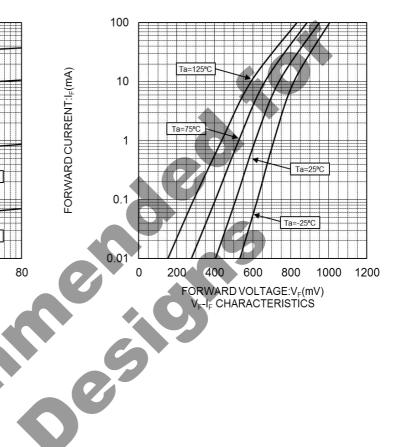
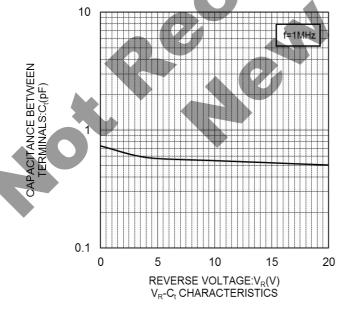
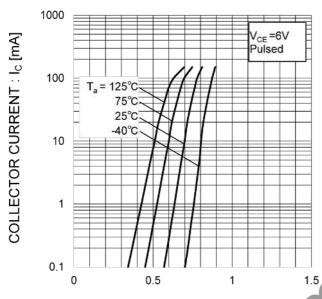


Fig.3 Capacitance Between Terminals vs. Reverse Voltage



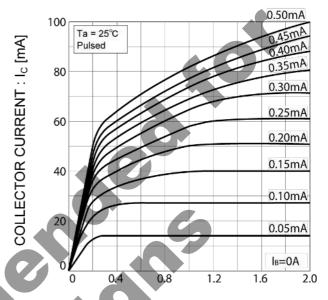
# ● Electrical characteristic curves(Ta=25°C) < For Transistor>

Fig.4 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE : VBE [V]

Fig.5 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.6 DC Current Gain vs. Collector Current (I)

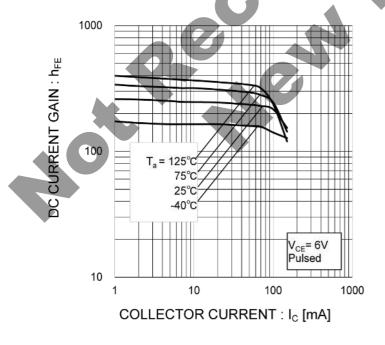
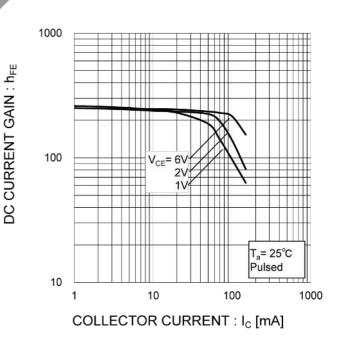


Fig.7 DC Current Gain vs. Collector Current (II)



## ● Electrical characteristic curves(Ta=25°C) < For Transistor>

Fig.8 Collector-Emitter Saturation Voltage vs. Collector Current (I)

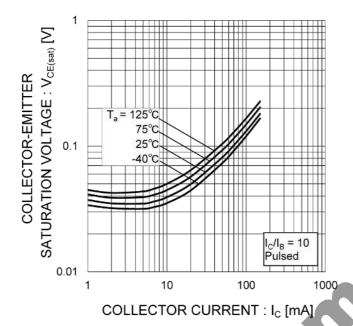


Fig.9 Collector-Emitter Saturation
Voltage vs. Collector Current (II)

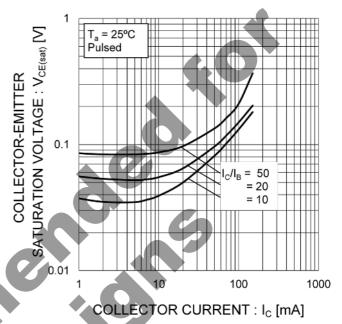


Fig.10 Base-Emitter Saturation Voltage vs. Collector Current

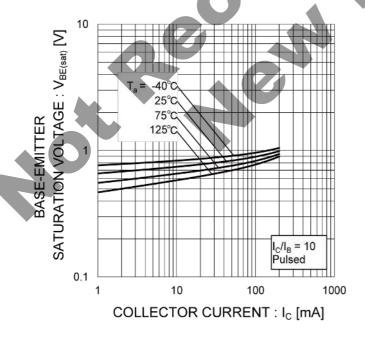
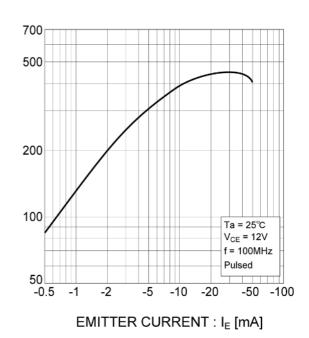


Fig.11 Gain Bandwidth Product vs. Emitter Current



TRANSITION FREQUENCY: fr [MHz]

## ● Electrical characteristic curves(T<sub>a</sub>=25°C) < For Transistor>

Fig.12 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

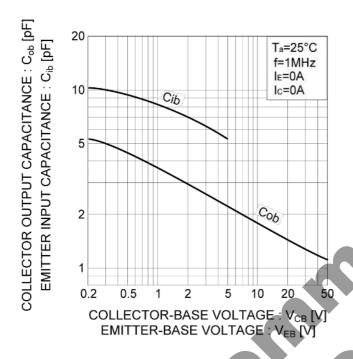
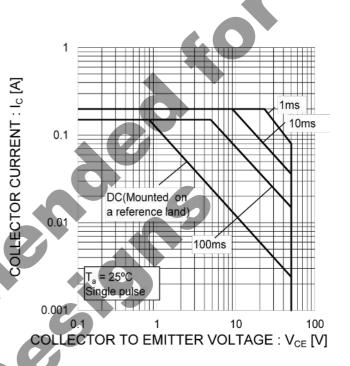
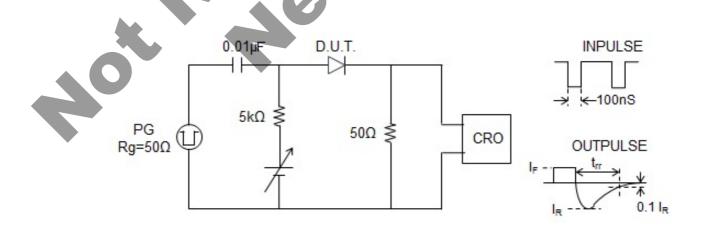


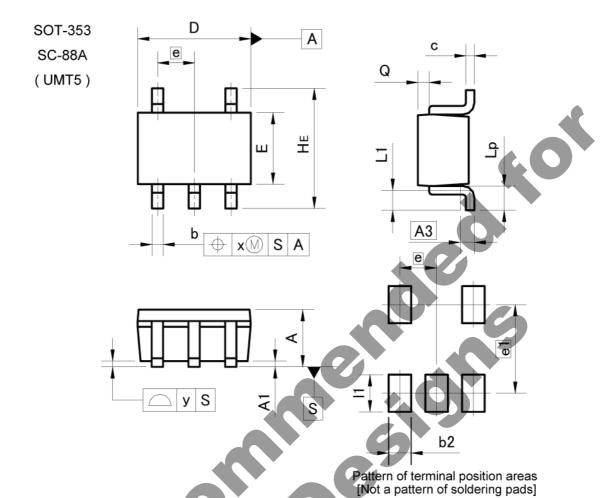
Fig.13 Safe Operating Area



(figure 1) Reverse recovery time test circuit



### Dimensions



DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
e	0.0	0.65		26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
x	<del></del> 0	0.10	e <del>n</del>	0.004
У	<del>55</del> 0	0.10	e <del>n</del>	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	<del></del>	0.40	057	0.016
e1	1.	1.55		061
11	<del>=</del> :	0.65	0 <del>50</del>	0.026

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCTI	CLASSIIb	СГАССШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
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  - [h] Use of the Products in places subject to dew condensation
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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